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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/890,455	03/12/2002	Hiroaki Inoue	2001-1091A	3064
513	7590 02/23/2004	EXAMINER		
WENDERO 2033 K STR	OTH, LIND & PONAC	GURLEY, LYNNE ANN		
SUITE 800 WASHINGTON, DC 20006-1021			ART UNIT	PAPER NUMBER
			2812	

DATE MAILED: 02/23/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

			\rightarrow \right		
•		Application No.	Applicant(s)		
`		09/890,455	INOUE ET AL.		
*.	Office Action Summary	Examiner	Art Unit		
		Lynne A. Gurley	2812		
Period fo	The MAILING DATE of this communication apor Reply	ppears on the cover sheet w	th the correspondence address		
THE - Exte after - If the - If NO - Failt - Any	ORTENED STATUTORY PERIOD FOR REP MAILING DATE OF THIS COMMUNICATION nsions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a report of the provision of the pro	I.  1.136(a). In no event, however, may a reply within the statutory minimum of third will apply and will expire SIX (6) MON ute, cause the application to become AE	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).		
1)⊠	Responsive to communication(s) filed on 04	<u> April 2003</u> .			
2a) <u></u> □	This action is <b>FINAL</b> . 2b)⊠ Thi	is action is non-final.			
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposit	ion of Claims		•		
5)□ 6)⊠ 7)□	Claim(s) 5-9 and 18-32 is/are pending in the 4a) Of the above claim(s) is/are withdred claim(s) is/are allowed.  Claim(s) 5-9 and 18-32 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and	rawn from consideration.			
ŕ	ion Papers	,			
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) and applicant may not request that any objection to the Replacement drawing sheet(s) including the correction as the article state of the second should be should b	ccepted or b) objected to ne drawing(s) be held in abeyar ection is required if the drawing	ce. See 37 CFR 1.85(a). s) is objected to. See 37 CFR 1.121(d).		
-	The oath or declaration is objected to by the lunder 35 U.S.C. §§ 119 and 120	Examiner. Note the attached	Office Action of Ioffit P10-132.		
12) \( \sigma \) 13) \( \sigma \) 3 4 14) \( \sigma \)	Acknowledgment is made of a claim for forei All b) Some * c) None of:  1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the pri application from the International Bure See the attached detailed Office action for a list Acknowledgment is made of a claim for domes ince a specific reference was included in the form of the translation of the foreign language packnowledgment is made of a claim for domes acknowledgment is made of a claim for domes	nts have been received.  nts have been received in A ionity documents have been au (PCT Rule 17.2(a)).  st of the certified copies not stic priority under 35 U.S.C. first sentence of the specific provisional application has bestic priority under 35 U.S.C.	pplication No received in this National Stage received. § 119(e) (to a provisional application) ation or in an Application Data Sheet. een received. §§ 120 and/or 121 since a specific		
Attachmen	ıt(s)				
2) Notic	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of I	ummary (PTO-413) Paper No(s)  Iformal Patent Application (PTO-152)		

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#### **DETAILED ACTION**

This office action is in response to the IDS filed 4/4/03, which was filed before the Notice of Allowance was mailed on 6/3/03 and, which was entered into the file after the Notice of Allowance was mailed 6/3/03. Due to the pertinent prior art listed in the IDS filed 4/4/03, the Notice of Allowance, mailed 6/3/03, has been withdrawn. A new office action on the merits is as follows:

#### **Drawings**

1. The drawings were received on 3/31/03. These drawings have been approved by the Examiner.

### Specification

2. The specification has not been checked to the extent necessary to determine the presence of all possible minor errors. Applicant's cooperation is requested in correcting any errors of which applicant may become aware in the specification.

#### Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 4. Claims 5-6, 8, 18 and 20-26 are rejected under 35 U.S.C. 102(e) as being anticipated by Cheung et al. (US 6,258,233, dated 7/10/01, filed 7/9/99).

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Cheung shows the method as claimed as depositing a seed layer in a feature of a substrate, depositing an electroless conductive layer conformally on the seed layer and electroplating a layer over the electroless layer to fill features on the substrate (column 3, lines 53-57). The electroless deposited copper layer fills defects and discontinuities in the seed layer (column 2, lines 42-46). The seed layer and the electroless deposition layer are both copper and, the copper sulfate in solution, which contains hydrogen and oxygen (copper sulfate produces dihydric copper ions in H<sub>2</sub>O as described in the specification of the instant invention) and disassociates into copper ions. A complexing agent of EDTA is used. An aldehyde acid is used – formaldehyde or glyoxylic acid. An organic alkali (TMAH) is used. (See column 3, lines 50-67 and column 4, lines 1-58.) The electroless deposition is performed at a rate of 400 Angstroms per minute (40 nm/min) (column 4, lines 54-55).

## Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
  - 1. Determining the scope and contents of the prior art.
  - 2. Ascertaining the differences between the prior art and the claims at issue.
  - 3. Resolving the level of ordinary skill in the pertinent art.

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4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

- 7. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 8. Claims 7, 19 and 27-32 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cheung et al. (US 6,258,233, dated 7/10/01) in view of Kikuchi et al. (US 4,563,217, dated 1/7/86).

Cheung shows the method as claimed and as described in the previous paragraphs.

Cheung lacks anticipation only in not teaching: 1) the details of the polyoxyethylene series surface active agent; 2) that the inlet size of the recess is less than 0.18 micron; 3) the concentration of copper ions from 0.01 to 10.0 g/L; 4) the concentration of the EDTA \* 4H being 0.5 to 100 g/L; 5) the glyoxylic acid concentration being 1 through 50 g/L and; 6) the pH being adjusted to a range of 10-14.

Kikuchi particularly shows, in a method using an electroless copper plating solution, details of the polyoxyethylene series surface active agent in the dependent claims. Also, the formation of cupric ions is reinforced by CuSO<sub>4</sub> \* 5H<sub>2</sub>O in Kikuchi, as taught in the specification

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of the instant invention. Kikuchi also teaches the concentrations of the copper ions, the EDTA,

the glyoxylic acid and the pH range.

It would have been obvious to one of ordinary skill in the art to have used the

polyoxyethylene series surface active agent, and to have used the cooper ions, the EDTA, the

glyoxylic acid and the pH range as claimed in the method of Cheung, with the motivation that

these ranges are reasonable for an electroless plating solution, as taught by Kikuchi.

Additionally, it would have been obvious to one of ordinary skill in the art to have had an inlet

size less than 0.18 micron, with the motivation that Cheung already shows deposition in a

contact hole, so that the size of the opening being less than 0.18 micron as technology is scaling

to the submicron ranges would be reasonable, especially in that the process taught in Cheung

yields excellent, enhanced results for such a structure.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Lynne A. Gurley whose telephone number is 703-305-3474. The

examiner can normally be reached on M-F 7:30-4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, John Niebling can be reached on 703-308-3325. The fax phone number for the

organization where this application or proceeding is assigned is 703-308-7722.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the receptionist whose telephone number is 308-308-0956.

LYNNE GURLEY PATENT EXAMINER

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November 19, 2003